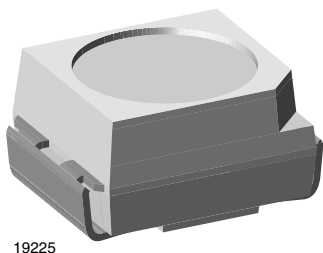


Power SMD LED PLCC-2



19225

DESCRIPTION

The package of the VLM.G33.. is the PLCC-2.

It consists of a lead frame which is embedded in a white thermoplast. The reflector inside this package is filled up with clear epoxy.

PRODUCT GROUP AND PACKAGE DATA

- Product group: LED
- Package: SMD PLCC-2
- Product series: power
- Angle of half intensity: $\pm 60^\circ$

FEATURES

- SMD LED with exceptional brightness
- Luminous intensity categorized
- Compatible with automatic placement equipment
- EIA and ICE standard package
- Compatible with IR reflow, vapor phase and wave solder processes according to CECC 00802 and J-STD-020
- Available in 8 mm tape
- Low profile package
- Non-diffused lens: excellent for coupling to light pipes and backlighting
- Low power consumption
- Luminous intensity ratio in one packaging unit $I_{Vmax}/I_{Vmin.} \leq 1.6$
- Preconditioning according to JEDEC® level 2a
- ESD-withstand voltage: up to 2 kV according to JESD22-A114-B
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



APPLICATIONS

- Automotive: backlighting in dashboards and switches
- Telecommunication: indicator and backlighting in telephone and fax
- Indicator and backlight for audio and video equipment
- Indicator and backlight in office equipment
- Flat backlight for LCDs, switches, and symbols
- General use

PARTS TABLE

PART	COLOR	LUMINOUS INTENSITY (mcd)			at I_F (mA)	WAVELENGTH (nm)			at I_F (mA)	FORWARD VOLTAGE (V)			at I_F (mA)	TECHNOLOGY
		MIN.	TYP.	MAX.		MIN.	TYP.	MAX.		MIN.	TYP.	MAX.		
VLMPG33N1P2-GS08	Pure green	28	42	71	30	555	560	565	30	-	2.0	2.5	30	AlInGaP on GaAs
VLMPG33N1P2-GS18	Pure green	28	42	71	30	555	560	565	30	-	2.0	2.5	30	AlInGaP on GaAs
VLMYG33P1Q2-GS08	Yellow green	45	90	112	30	566	570	577	30	1.7	2.0	2.5	30	AlInGaP on GaAs
VLMYG33P1Q2-GS18	Yellow green	45	90	112	30	566	570	577	30	1.7	2.0	2.5	30	AlInGaP on GaAs

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25^\circ\text{C}$ unless otherwise specified) VLMPG33.., VLMYG33..

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage ⁽¹⁾		V_R	5	V
DC forward current	$T_{amb} \leq 73^\circ\text{C}$	I_F	50	mA
Surge forward current	$t_p \leq 10 \mu\text{s}$	I_{FSM}	0.2	A
Power dissipation		P_V	130	mW
Junction temperature		T_j	125	$^\circ\text{C}$
Operating temperature range		T_{amb}	-40 to +100	$^\circ\text{C}$
Storage temperature range		T_{stg}	-40 to +100	$^\circ\text{C}$
Thermal resistance junction / ambient	Mounted on PC board (pad size > 16 mm ²)	R_{thJA}	400	K/W

Note

⁽¹⁾ Driving LED in reverse direction is suitable for short term application

**OPTICAL AND ELECTRICAL CHARACTERISTICS** ($T_{amb} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)
VLMPG33.., PURE GREEN

PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Luminous intensity	$I_F = 30\text{ mA}$	VLMPG33N1P2	I_V	28	42	71	mcd
Dominant wavelength	$I_F = 30\text{ mA}$		λ_d	555	560	565	nm
Peak wavelength	$I_F = 30\text{ mA}$		λ_p	-	565	-	nm
Angle of half intensity	$I_F = 30\text{ mA}$		ϕ	-	± 60	-	deg
Forward voltage	$I_F = 30\text{ mA}$		V_F	-	2.0	2.5	V
Reverse voltage	$I_R = 10\text{ }\mu\text{A}$		V_R	5	-	-	V
Temperature coefficient of V_F	$I_F = 30\text{ mA}$		T_{CV}	-	-4	-	mV/K
Temperature coefficient of I_V	$I_F = 30\text{ mA}$		T_{CI}	-	-0.4	-	%/K

OPTICAL AND ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)
VLMYG33.., YELLOW GREEN

PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Luminous intensity	$I_F = 30\text{ mA}$	VLMYG33P1Q2	I_V	45	90	112	mcd
Luminous flux/luminous intensity			Φ_V/I_V	-	3	-	mlm/mcd
Dominant wavelength	$I_F = 30\text{ mA}$		λ_d	566	570	577	nm
Peak wavelength	$I_F = 30\text{ mA}$		λ_p	-	-	-	nm
Spectral bandwidth at 50 % $I_{rel\text{ max.}}$	$I_F = 30\text{ mA}$		$\Delta\lambda$	-	18	-	nm
Angle of half intensity	$I_F = 30\text{ mA}$		ϕ	-	± 60	-	deg
Forward voltage	$I_F = 30\text{ mA}$		V_F	1.7	2.0	2.5	V
Reverse voltage	$I_R = 10\text{ }\mu\text{A}$		V_R	5	-	-	V
Temperature coefficient of V_F	$I_F = 30\text{ mA}$		T_{CV}	-	-4	-	mV/K
Temperature coefficient of I_V	$I_F = 30\text{ mA}$		T_{CI}	-	-0.04	-	%/K

LUMINOUS INTENSITY CLASSIFICATION

GROUP	LUMINOUS INTENSITY (mcd)		
STANDARD	OPTIONAL	MIN.	MAX.
L	1	11.2	14.0
	2	14.0	18.0
M	1	18.0	22.4
	2	22.4	28.0
N	1	28.0	35.5
	2	35.5	45.0
P	1	45.0	56.0
	2	56.0	71.0
Q	1	71.0	90.0
	2	90.0	112.0

Note

- Luminous intensity is tested at a current pulse duration of 25 ms and an accuracy of $\pm 11\%$.
The above type numbers represent the order groups which include only a few brightness groups. Only one group will be shipped on each reel (there will be no mixing of two groups on each reel).
In order to ensure availability, single brightness groups will not be orderable.
In a similar manner for colors where wavelength groups are measured and binned, single wavelength groups will be shipped on any one reel.
In order to ensure availability, single wavelength groups will not be orderable.

COLOR CLASSIFICATION

GROUP	DOMINANT WAVELENGTH (nm)			
	PURE GREEN		YELLOW GREEN	
	MIN.	MAX.	MIN.	MAX.
0	555	559		
1	558	561		
2	560	563		
3	562	565		
4				
5			566	569
6			568	571
7			570	573
8			572	575
9			574	577

Note

- Wavelengths are tested at a current pulse duration of 25 ms.

CROSSING TABLE

VISHAY	OSRAM
VLMPG33N1P2	LPT675N1P2
VLMYG33P1Q2	LGT676

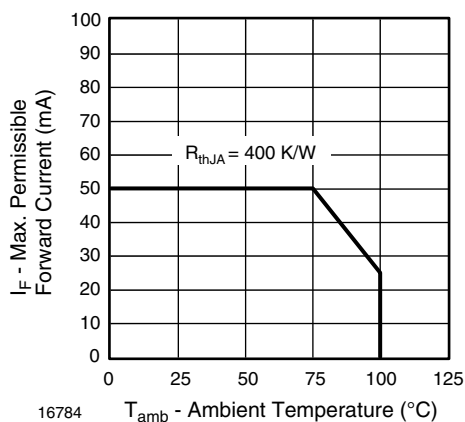
TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)


Fig. 1 - Forward Current vs. Ambient Temperature

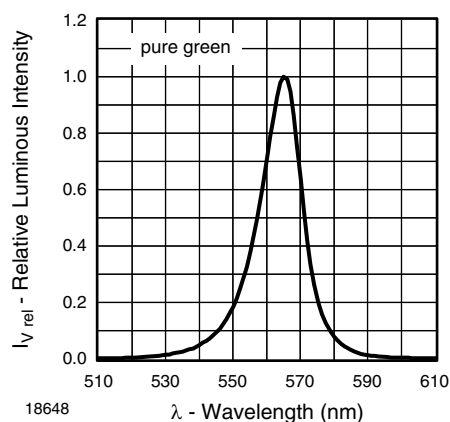


Fig. 4 - Relative Luminous Intensity vs. Wavelength

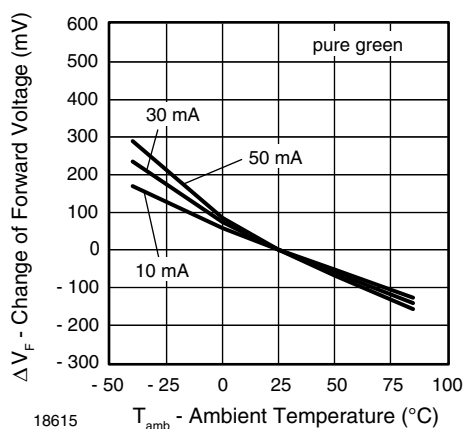


Fig. 2 - Change of Forward Voltage vs. Ambient Temperature

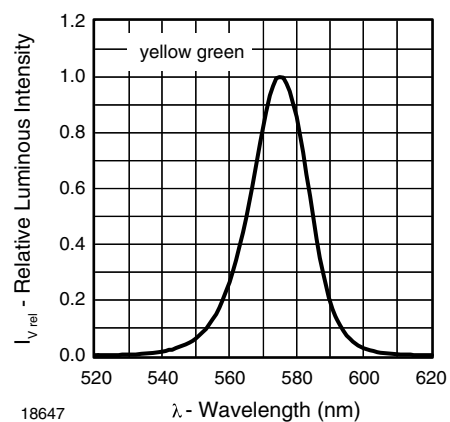


Fig. 5 - Relative Luminous Intensity vs. Wavelength

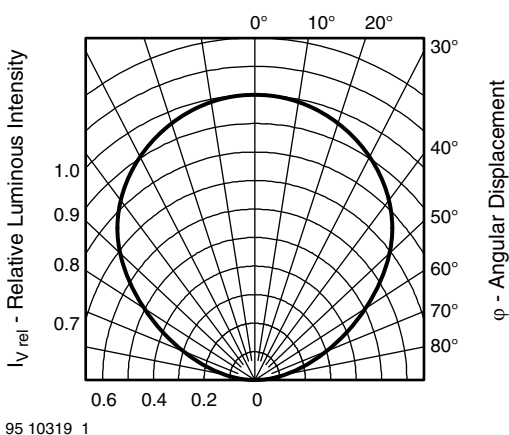


Fig. 3 - Relative Luminous Intensity vs. Angular Displacement

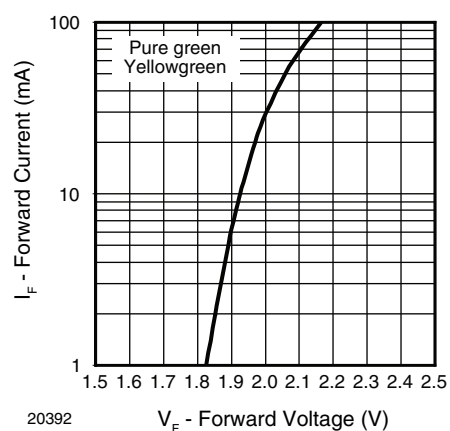


Fig. 6 - Forward Current vs. Forward Voltage

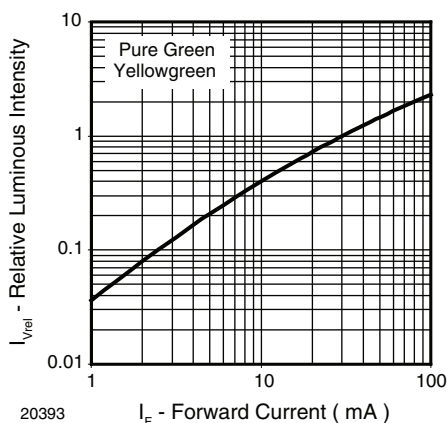


Fig. 7 - Relative Luminous Intensity vs. Forward Current

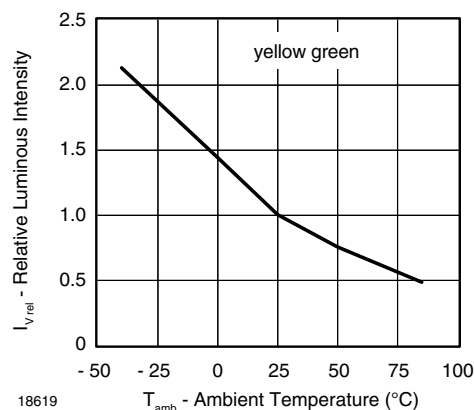


Fig. 10 - Relative Luminous Intensity vs. Ambient Temperature

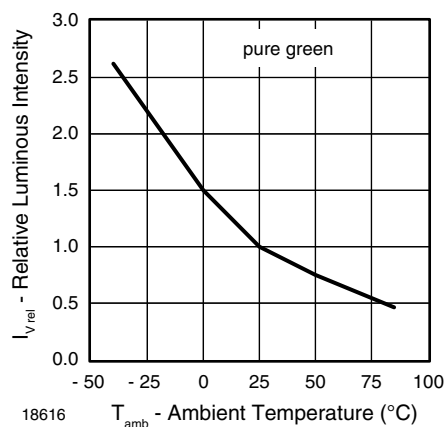


Fig. 8 - Relative Luminous Intensity vs. Ambient Temperature

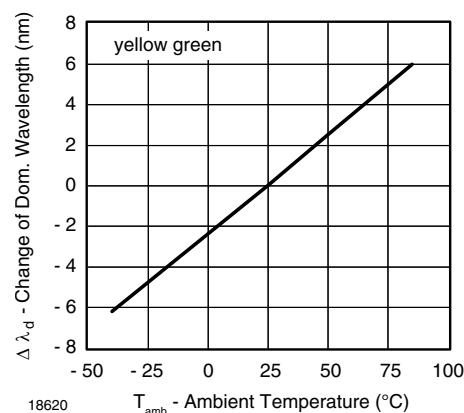


Fig. 11 - Change of Dominant Wavelength vs. Ambient Temperature

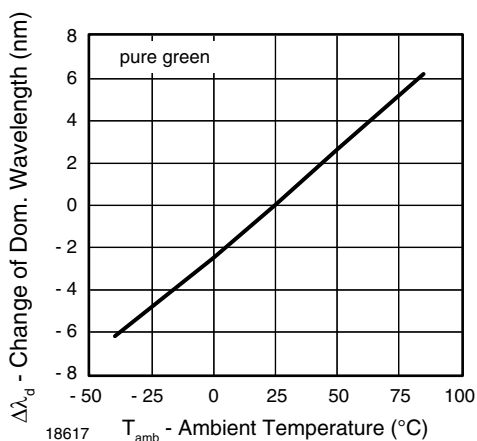
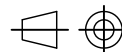
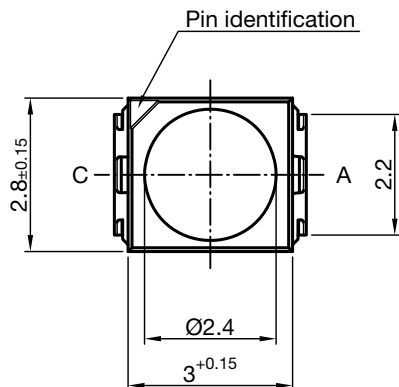
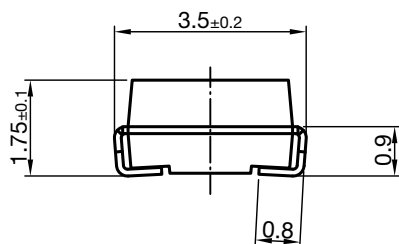


Fig. 9 - Change of Dominant Wavelength vs. Ambient Temperature



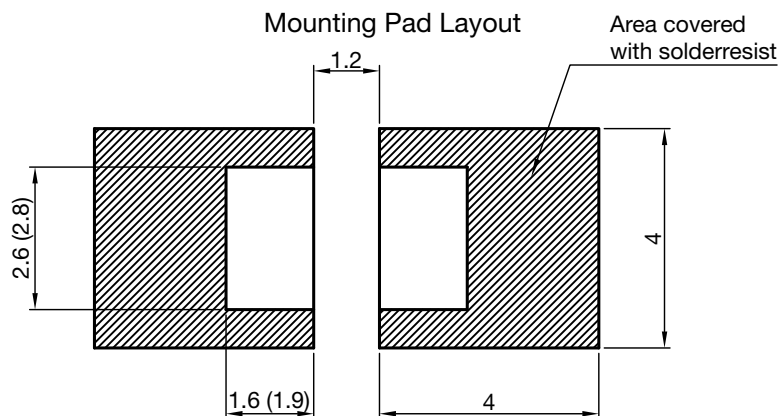
PACKAGE DIMENSIONS in millimeters



Technical drawings
according to DIN
specifications

Dimensions in mm

Drawing-No.: 6.541-5067.01-4
Issue: 6; 23.09.13

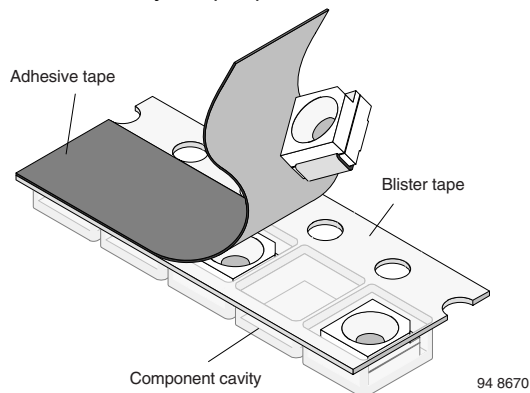


Dimensions: Reflow and vapor phase (wave soldering)

METHOD OF TAPING / POLARITY AND TAPE AND REEL

SMD LED (VLM.3-SERIES)

Vishay's LEDs in SMD packages are available in an antistatic 8 mm blister tape (in accordance with DIN IEC 40 (CO) 564) for automatic component insertion. The blister tape is a plastic strip with impressed component cavities, covered by a top tape.



TAPING OF VLM.3...

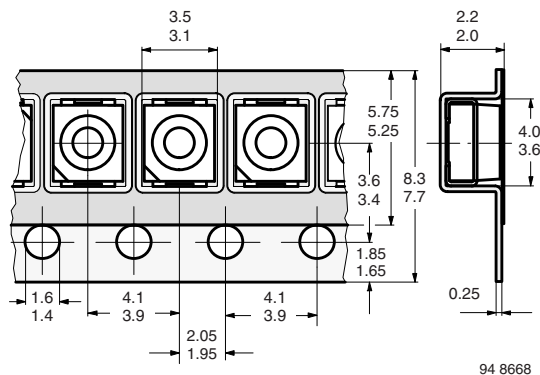


Fig. 12 - Tape Dimensions in mm for PLCC-2

REEL PACKAGE DIMENSION IN MILLIMETERS FOR SMD LEDs, TAPE OPTION GS08 (= 1500 PCS.)

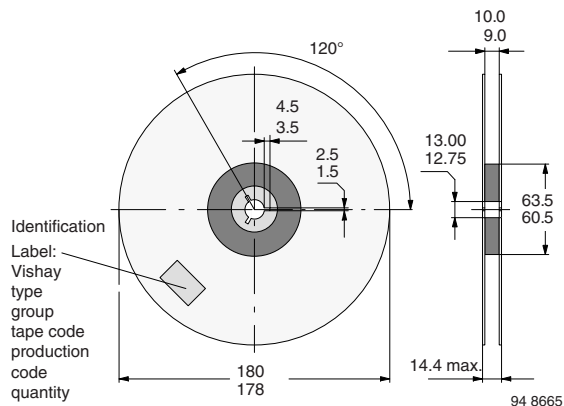


Fig. 13 - Reel Dimensions - GS08

REEL PACKAGE DIMENSION IN MILLIMETERS FOR SMD LEDs, TAPE OPTION GS18 (= 8000 PCS.) PREFERRED

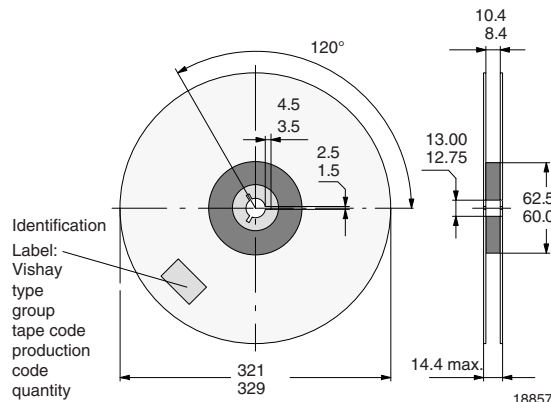


Fig. 14 - Reel Dimensions - GS18

SOLDERING PROFILE

IR Reflow Soldering Profile for Lead (Pb)-free Soldering
Preconditioning acc. to JEDEC level 2a

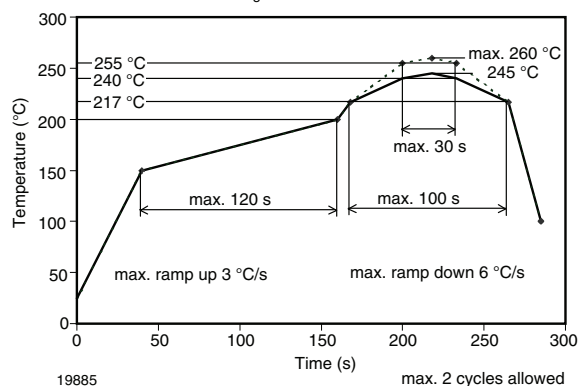


Fig. 15 - Vishay Lead (Pb)-free Reflow Soldering Profile (acc. to J-STD-020)

TTW Soldering (acc. to CECC00802)

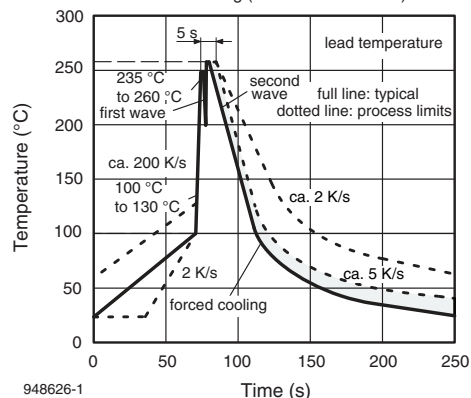
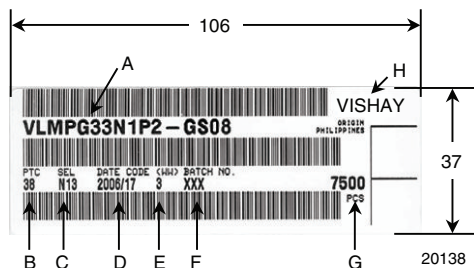


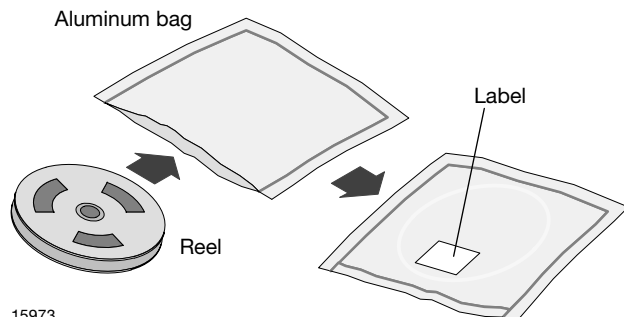
Fig. 16 - Double Wave Soldering of Opto Devices (all Packages)

BAR CODE PRODUCT LABEL


- A) Type of component
- B) Manufacturing plant
- C) SEL - selection code (bin):
e.g.: N1 = code for luminous intensity group
3 = code for color group
- D) Date code year / week
- E) Day code (e.g. 3: Wednesday)
- F) Batch no.
- G) Total quantity
- H) Company code

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.


FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminium bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 672 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:
192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or
96 h at 60 °C + 5 °C and < 5 % RH for all device containers or
24 h at 100 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC standard JESD22-A112 level 2a label is included on all dry bags.

	CAUTION This bag contains MOISTURE-SENSITIVE DEVICES	LEVEL 2a
1. Shelf life in sealed bag 12 months at <40°C and < 90% relative humidity (RH)		
2. After this bag is opened devices that will be subjected to infrared reflow, vapor-phase reflow, or equivalent processing (peak package body temp. 260°C) must be: a) Mounted within 672 hours at factory condition of ≤ 30°C/60%RH or b) Stored at ≤10% RH.		
3. Devices require baking before mounting if: a) Humidity Indicator Card is >10% when read at 23°C ± 5°C or b) 2a or 2b is not met.		
4. If baking is required, devices may be baked for: 192 hours at 40°C + 5°C/-0°C and <5%RH (dry air/nitrogen) or 96 hours at 60±5°C and <5%RH For all device containers or 24 hours at 100±5°C Not suitable for reels or tubes		
Bag Seal Date: _____ (If blank, see bar code label)		
Note: LEVEL defined by EIA JEDEC Standard JESD22-A113		

Example of JESD22-A112 Level 2a Label

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



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Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

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